

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicants: JEUN et al.

Serial No.: 09/677,558

Title: Semiconductor Power Module
Having an Electrically Insulating Heat Sink
and Method of Manufacturing the Same

Filed: September 29, 2000


Group Art Unit: 2814

Examiner: Nguyen, DiLinh P.

Atty. Docket Number: 29347/990488

Customer No.: 04743

) I hereby certify that this paper and the
) documents referred to as enclosed
) therewith are being deposited with the
) United States Postal Service as first
) class mail, postage prepaid, in an
) envelope addressed to: Mail Stop RCE,
) Commissioner for Patents, P.O. Box
) 1450, Alexandria, Virginia 22313-1450,
) on the date indicated: **February 3,**
) **2006.**



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INFORMATION DISCLOSURE STATEMENT

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Pursuant to 37 CFR 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached Form PTO-1449. It is respectfully requested that the information be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

Copies of all non-U.S. patent documents and non-U.S. published patent application documents on the PTO-1449 form are attached.

In accordance with 37 CFR 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 CFR 1.56(a) exists. In accordance with 37 CFR 1.97(h), the filing of this Information Disclosure statement shall not be construed to be an

admission that any patent, publication or other information referred to therein is "prior art" for this invention unless specifically designated as such.

TIME OF FILING

This information disclosure statement is being filed, to the best of the undersigned's knowledge, before the mailing date of a first Office action on the merits. In accordance with 37 CFR §1.97(b), no certification or fee is required.

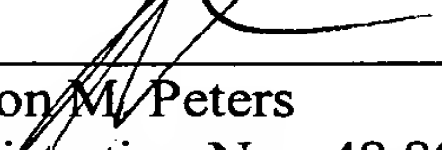
METHOD OF PAYMENT

It is submitted that the Information Disclosure Statement is in compliance with 37 CFR 1.98 and the Examiner is respectfully requested to consider the listed references.

The Director is hereby authorized to charge any deficiency in the fees filed, asserted to be filed or which should have been filed herewith (or with any paper hereafter filed in this application by this firm) to our Deposit Account No. 13-2855, under Order No. 29347/990488. A duplicate copy of this paper is enclosed.

Respectfully submitted,

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February 3, 2006

For PTO-1449 (Modified) U.S. Department of Commerce Patent and Trademark Office INFORMATION DISCLOSURE STATEMENT	Atty. Docket No. 29347/990488	Serial No. 09/677,558
	Applicant JEUN et al.	
	Filing Date September 29, 2000	Group 2814

U.S. PATENT DOCUMENTS							
*Examiner Initials		Document Number	Issue Date	Name	Class	Subclass	Filing Date if Appropriate

U.S. PATENT APPLICATION PUBLICATIONS							
*Examiner Initials		Document Number	Publication Date	Name	Class	Subclass	Filing Date if Appropriate

FOREIGN PATENT DOCUMENTS								
*Examiner Initials		Document Number	Publication Date	Country	Class	Subclass	Translation	
							Yes	No
		05299576	11/12/93	Japan	H01L25	07	Abstract	
		10093015	04/10/98	Japan	H01L25	07	Abstract	
		DE69614195	04/18/02	Germany	H01L23	48	Abstract	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		

Examiner	Date Considered
*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	